

Discription

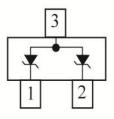
The SM05T1G protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD. It gives designer the flexibility to protect 2 unidirectional line in applications where arrays are not practical.



SOT-23

Features

- 2 Unidirectional transil functions
- ◆ Reverse stand-off voltage: 5V Max
- ◆ Low leakage current: nA Level
- ◆ Response time is typically < 1 ns</p>
- ◆ Transient protection for each line according to IEC61000-4-2(ESD) 15KV(air) 8KV(contact) IEC61000-4-5(Lightning) see I_{PPM} below



Circuit Diagram

Ordering information

Product ID	Pack	Qty(PCS)
SM05T1G	SOT-23	3000

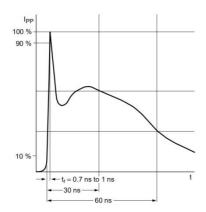
Absolute Ratings (T_{amb}=25°C)

Paramete	Symbol	Value	Unit	
Peak Pulse Power (8/20μs)	Ppk	130	W	
Lead Solder Temperature – Maximum	TL	260	$^{\circ}$ C	
(10 Second Duration) ESD per IEC61000-4-2 (Air)		±15	10.7	
ESD per IEC61000-4-2 (Contact)	V _{ESD}	±8	KV	
Operating Temperature Range	TJ	-40 to +125	$^{\circ}\!\mathbb{C}$	
Storage Temperature Range	Tstg	-55 to +150	°C	

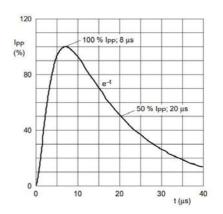


Electrical Characteristics (T_A=25°C unless otherwise specified)

Paramete	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Working Voltage	V _{RWM}			5.0	V	
Breakdown Voltage	V_{BR}	6.2			V	I _⊤ =1mA
Leakage Current ILeak	I _R			100	nA	V _{RWM} =5V
Clamping Voltage	Vc			13.0	V	I _{PP} =10A,Tp=8/20μs
Peak Pulse Current	I _{PP}			10.0	Α	Tp=8/20µs
Junction Capacitance	C _J		60	80	pF	V _R =0V, f=1MHz
						(Pin 1 or 2 to 3)
Junatian Canaditanas	CJ			40	pF	V _R =0V, f=1MHz
Junction Capacitance						(Pin 1 to 2 and 2 to 1)

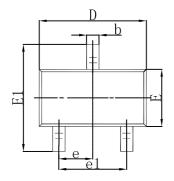


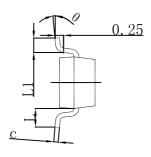
IEC61000-4-2 Waveform

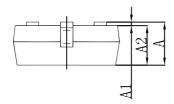


8/20 µs Pulse Waveform

SOT-23 Package Outline Dimensions

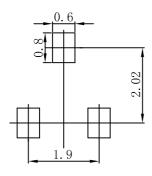






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

SOT-23 Suggested Pad Layout



- Note:
 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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